ANALOG

DEVICES

## FEATURES

## Dual 2:1 mux/1:2 demux

Optimized for dc to 6.5 Gbps NRZ data
Per-lane P/N pair inversion for routing ease
Programmable input equalization
Compensates up to 40 inches of FR4

## Loss-of-signal detection

Programmable output preemphasis up to 12 dB
Programmable output levels with squelch and disable
Accepts ac-coupled or dc-coupled differential CML inputs
$50 \Omega$ on-chip termination
1:2 demux supports unicast or bicast operation
Port-level loopback
Port or single lane switching
1.8 V to 3.3 V flexible core supply

User-settable I/O supply from $\mathrm{V}_{\mathrm{cc}}$ to 1.2 V
Low power, typically 2.0 W in basic configuration
64-lead LFCSP
$-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ operating temperature range

## APPLICATIONS

## Low cost redundancy switch

SONET OC48/SDH16 and lower data rates
RXAUI, $4 \times$ Fibre Channel, Infiniband, and GbE over backplane
OIF CEI 6.25 Gbps over backplane
Serial data-level shift
2-/4-/6-lane equalizers or redrivers

## GENERAL DESCRIPTION

The AD8155 is an asynchronous, protocol-agnostic, dual-lane 2:1 switch with a total of six differential CML inputs and six differential CML outputs. The signal path supports NRZ signaling with data rates up to 6.5 Gbps per lane. Each lane offers programmable receive equalization, programmable output preemphasis, programmable output levels, and loss-ofsignal detection.

The nonblocking switch core of the AD8155 implements a 2:1 multiplexer and 1:2 demultiplexer per lane and supports independent lane switching through the two select pins, SEL[1:0]. Each port is a two-lane link. Every lane implements an asynchronous path supporting dc to 6.5 Gbps NRZ data, fully independent of other lanes. The AD8155 has low latency and very low lane-to-lane skew.

## Rev. 0

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## FUNCTIONAL BLOCK DIAGRAM



Figure 1.

The main application of the AD8155 is to support redundancy on both the backplane and the line interface sides of a serial link. The demultiplexing path implements unicast and bicast capability, allowing the part to support either $1+1$ or 1:1 redundancy.

The AD8155 is also suited for testing high speed serial links because of its ability to duplicate incoming data. In a portmonitoring application, the AD8155 can maintain link connectivity with a pass-through connection from Port C to Port A while sending a duplicate copy of the data to test equipment on Port B.
The rich feature set of the AD8155 can be controlled either through external toggle pins or by setting on-chip control registers through the $\mathrm{I}^{2} \mathrm{C}^{\ominus}$ interface.

## AD8155

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## REVISION HISTORY

## 7/09—Revision 0: Initial Version

## SPECIFICATIONS

$\mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{TTI}}=\mathrm{V}_{\mathrm{TTO}}=1.8 \mathrm{~V}, \mathrm{DV}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$, basic configuration ${ }^{1}$, data rate $=6.5 \mathrm{Gbps}$, data pattern $=\mathrm{PRBS} 7$, accoupled inputs and outputs, differential input swing $=800 \mathrm{mV}$ p-p, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.

Table 1.

| Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE <br> Data Rate/Channel (NRZ) <br> Deterministic Jitter (No Channel) <br> Random Jitter (No Channel) <br> Residual Deterministic Jitter with Receive Equalization <br> Residual Deterministic Jitter with Transmit Preemphasis <br> Propagation Delay <br> Lane-to-Lane Skew <br> Switching Time <br> Output Rise/Fall Time | Data rate $=6.5 \mathrm{Gbps}$, EQ setting $=0$ <br> RMS, data rate $=6.5 \mathrm{Gbps}$ <br> Data rate $6.5 \mathrm{Gbps}, 20$ inch FR4 <br> Data rate $6.5 \mathrm{Gbps}, 40$ inch FR4 <br> Data rate $6.5 \mathrm{Gbps}, 10$ inch FR4 <br> Data rate $6.5 \mathrm{Gbps}, 30$ inch FR4 <br> $50 \%$ input to $50 \%$ output (maximum EQ) <br> Signal path and switch architecture is balanced <br> and symmetric (maximum EQ) <br> $50 \%$ logic switching to $50 \%$ output data <br> 20\% to 80\% (PE = lowest setting) | DC | 22 1 30 40 35 42 700 90 150 62 | 6.5 | Gbps ps p-p ps ps p-p ps p-p ps p-p ps p-p ps ps $n s$ ns |
| INPUT CHARACTERISTICS <br> Differential Input Voltage Swing <br> Input Voltage Range | $\mathrm{V}_{\text {Icm }}{ }^{2}=\mathrm{V}_{\text {cc }}-0.6 \mathrm{~V}, \mathrm{~V}_{\text {cc }}=\mathrm{V}_{\text {MII }}$ to $\mathrm{V}_{\text {MAX }}, \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MII }}$ to $\mathrm{T}_{\text {MAX }}$, <br> LOS control register $=0 \times 05$ <br> Single-ended absolute voltage level, $\mathrm{V}\llcorner$ minimum Single-ended absolute voltage level, $\mathrm{V}_{\mathrm{H}}$ maximum | 200 | $\begin{aligned} & \mathrm{V}_{\mathrm{EE}}+0.6 \\ & \mathrm{~V}_{\mathrm{CC}}+0.3 \end{aligned}$ | 2000 | $\begin{aligned} & \begin{array}{l} \mathrm{mV} p-\mathrm{p} \\ \text { diff } \end{array} \\ & \mathrm{V} \\ & \mathrm{~V} \end{aligned}$ |
| OUTPUT CHARACTERISTICS <br> Output Voltage Swing <br> Output Voltage Range, SingleEnded Absolute Voltage Level <br> Output Current | Differential, $\mathrm{PE}=0$, default output level, @ dc <br> TX_HEADROOM $=0, V_{\llcorner }$minimum <br> TX_HEADROOM $=0, V_{H}$ maximum <br> TX_HEADROOM $=1, V_{\llcorner }$minimum <br> TX_HEADROOM $=1, \mathrm{~V}_{\mathrm{H}}$ maximum <br> Port $A / B / C, P E \_A / B / C=$ minimum <br> Port A/B/C, PE_A/B/C $=6 \mathrm{~dB}, V_{\text {od }}=800 \mathrm{mV}$ p-p | 590 | $\begin{aligned} & 725 \\ & V_{c c}-1.1 \\ & V_{c c}+0.6 \\ & V_{\mathrm{cc}}-1.3 \\ & V_{c \mathrm{c}}+0.6 \\ & 16 \\ & 32 \end{aligned}$ | 820 | $\begin{aligned} & \mathrm{mV} \mathrm{p}-\mathrm{p} \\ & \mathrm{diff} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \end{aligned}$ |
| TERMINATION CHARACTERISTICS Resistance | Differential, $\mathrm{V}_{\text {CC }}=\mathrm{V}_{\text {MIN }}$ to $\mathrm{V}_{\text {MAX }}, \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ | 90 | 100 | 110 | $\Omega$ |
| LOS CHARACTERISTICS <br> DC Assert Level <br> DC Deassert Level <br> LOS to Output Squelch <br> LOS to Output Enable | $\begin{aligned} & \mathrm{LOS} \text { control }=0, \mathrm{~V}_{\mathrm{ID}}=0 \text { to } 50 \% \mathrm{OP} / \mathrm{ON} \text { settling, } \\ & \mathrm{V}_{\mathrm{CC}}=1.8 \mathrm{~V} \\ & \mathrm{LOS} \text { control }=0 \text {, data present to first valid } \\ & \text { transition, } \mathrm{V}_{\mathrm{CC}}=1.8 \mathrm{~V} \end{aligned}$ |  | 50 <br> 300 <br> 21 <br> 67 |  | $\begin{aligned} & m V p-p \\ & \text { diff } \\ & m V p-p \\ & \text { diff } \\ & \text { ns } \\ & \text { ns } \end{aligned}$ |
| POWER SUPPLY <br> Operating Range Vcc <br> DV ${ }_{\text {cc }}$ <br> $V_{\text {TII }}$ <br> $V_{\text {тто }}$ | $\mathrm{V}_{\mathrm{EE}}=0 \mathrm{~V}$, TX_HEADROOM $=0$ <br> $\mathrm{V}_{\mathrm{EE}}=0 \mathrm{~V}$, TX_HEADROOM $=1$ <br> $\mathrm{DV}_{\mathrm{CC}} \geq \mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{EE}}=0 \mathrm{~V}$ | $\begin{aligned} & 1.6 \\ & 2.2 \\ & 1.6 \\ & 1.2 \\ & 1.2 \end{aligned}$ | $\begin{aligned} & 1.8 \text { to } 3.3 \\ & 3.3 \\ & 1.8 \text { to } 3.3 \end{aligned}$ | $\begin{aligned} & 3.6 \\ & 3.6 \\ & 3.6 \\ & V_{c \mathrm{c}}+0.3 \\ & \mathrm{~V}_{\mathrm{cc}}+0.3 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |


| Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Current Icc |  |  |  |  |  |
| $\mathrm{V}_{\text {cc }}=1.8 \mathrm{~V}$ | $L B \_x=0, P E=0 \mathrm{~dB}$ on all ports, low power mode ${ }^{3}$ |  | 233 | 270 | mA |
|  | $L B \_x=1, P E=6 \mathrm{~dB}$ on all ports, low power mode ${ }^{3}$ |  | 406 | 480 | mA |
|  | $L B \_x=0, P E=0 \mathrm{~dB}$ on all ports, default |  | 350 | 410 | mA |
|  | $L B \_x=1, P E=6 \mathrm{~dB}$ on all ports, default |  | 690 | 800 | mA |
| $\mathrm{V}_{\mathrm{cc}}=3.3 \mathrm{~V}$ | $L B \times x=0, P E=0 \mathrm{~dB}$ on all ports, low power mode ${ }^{3}$ |  | 254 | 300 | mA |
|  | $L B \_x=1, P E=6 \mathrm{~dB}$ on all ports, low power mode ${ }^{3}$ |  | 435 | 500 | mA |
|  | $L B \_x=0, P E=0 d B$ on all ports, default |  | 380 | 450 | mA |
|  | $L B \_x=1, P E=6 d B$ on all ports, default |  | 735 | 850 | mA |
| Iто |  |  |  |  |  |
| $\mathrm{V}_{\text {то }}=1.8 \mathrm{~V}$ | $L B \_x=0, P E=0 \mathrm{~dB}$ on all ports, low power mode ${ }^{3}$ |  | 66 | 82 | mA |
|  | $L B \times x=1, P E=6 \mathrm{~dB}$ on all ports, low power mode ${ }^{3}$ |  | 186 | 226 | mA |
|  | LB_x $=0, \mathrm{PE}=0 \mathrm{~dB}$ on all ports, default |  | 66 | 82 | mA |
|  | $L B \_x=1, P E=6 \mathrm{~dB}$ on all ports, default |  | 183 | 225 | mA |
| $\mathrm{V}_{\text {T0 }}=3.3 \mathrm{~V}$ | $L B \times x=0, P E=0 \mathrm{~dB}$ on all ports, low power mode ${ }^{3}$ |  | 69 | 85 | mA |
|  | $L B \times x=1, P E=6 \mathrm{~dB}$ on all ports, low power mode ${ }^{3}$ |  | 195 | 230 | mA |
|  | $L B \_x=0, P E=0 \mathrm{~dB}$ on all ports, default |  | 69 | 84 | mA |
|  | LB_x $=1, \mathrm{PE}=6 \mathrm{~dB}$ on all ports, default |  | 193 | 230 | mA |
| 1 |  |  | 10 | 20 | mA |
| Iovce |  |  | 2 | 4 | mA |
| THERMAL CHARACTERISTICS |  |  |  |  |  |
| Operating Temperature Range |  | -40 |  | +85 | ${ }^{\circ} \mathrm{C}$ |
| $\theta_{\mathrm{JA}}$ | Still air; JEDEC 4-layer test board, exposed pad soldered |  | 21.2 |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta_{\text {лc }}$ | Still air; thermal resistance through exposed pad |  | 1.1 |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Maximum Junction Temperature |  |  |  | 125 | ${ }^{\circ} \mathrm{C}$ |
| LOGIC CHARACTERISTICS ${ }^{4}$ | $1^{2} \mathrm{C}, \mathrm{SDA}, \mathrm{SCL}$, control pins |  |  |  |  |
| Input High ( $\mathrm{V}_{\mathbf{H}}$ ) | $\mathrm{DV}_{\mathrm{cc}}=3.3 \mathrm{~V}$ | $0.7 \times \mathrm{DV}_{\text {cc }}$ |  | DV ${ }_{\text {cc }}$ | V |
| Input Low (V) | $\mathrm{DV}_{\mathrm{cc}}=3.3 \mathrm{~V}$ | $\mathrm{V}_{\mathrm{EE}}$ |  | $0.3 \times$ DV ${ }_{\text {cc }}$ | V |
| Input High ( $\mathrm{V}_{\text {H }}$ ) | DV $\mathrm{cc}_{\text {c }}=1.8 \mathrm{~V}$ |  | $0.8 \times$ DV ${ }_{\text {cc }}$ | DV cc | V |
| Input Low (Vı) | $\mathrm{DV}_{\mathrm{cc}}=1.8 \mathrm{~V}$ | $\mathrm{V}_{\text {EE }}$ | $0.2 \times \mathrm{DV}_{\text {cc }}$ |  | V |
| Output High ( $\mathrm{V}_{\text {OH }}$ ) | $2 \mathrm{k} \Omega$ pull-up resistor to $\mathrm{DV}_{\text {cc }}$ |  | DV ${ }_{\text {cc }}$ |  | V |
| Output Low (VoL) | $\mathrm{loL}=+3 \mathrm{~mA}$ | $\mathrm{V}_{\text {EE }}$ |  | 0.4 | V |

[^0]
## I ${ }^{2}$ C TIMING SPECIFICATIONS



NOTES
$\begin{array}{ll}\text { 1. } \mathrm{S}=\text { START CONDITION. } & \text { Ö } \\ \text { 2. } \mathrm{Sr}=\text { REPEAT START. } & \text { © } \\ \text { 3. } \mathrm{P}=\text { STOP. }\end{array}$
Figure 2. $1^{2}$ C Timing Diagram
Table 2. $\mathrm{I}^{2} \mathrm{C}$ Timing Parameters

| Parameter | Symbol | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: |
| SCL Clock Frequency | fscl | 0 | 400+ | kHz |
| Hold Time for a Start Condition | $\mathrm{t}_{\text {HD; }}$ STA | 0.6 |  | $\mu \mathrm{s}$ |
| Setup Time for a Repeated Start Condition | $\mathrm{t}_{\text {su;STA }}$ | 0.6 |  | $\mu \mathrm{s}$ |
| Low Period of the SCL Clock | tlow | 1.3 |  | $\mu \mathrm{s}$ |
| High Period of the SCL Clock | thigh | 0.6 |  | $\mu s$ |
| Data Hold Time | $\mathrm{t}_{\text {HD; DAT }}$ | 0 |  | $\mu s$ |
| Data Setup Time | $\mathrm{t}_{\text {Su; }{ }_{\text {dat }}}$ | 10 |  | ns |
| Rise Time for Both SDA and SCL | $\mathrm{t}_{\mathrm{R}}$ | 1 | 300 | ns |
| Fall Time for Both SDA and SCL | $\mathrm{t}_{\mathrm{F}}$ | 1 | 300 | ns |
| Setup Time for Stop Condition | $\mathrm{t}_{\text {su;STo }}$ | 0.6 |  | $\mu s$ |
| Bus Free Time Between a Stop and a Start Condition | $\mathrm{t}_{\text {BUF }}$ | 1 |  | $\mu s$ |
| Bus Free Time After a Reset |  | 1 |  | $\mu s$ |
| Reset Pulse Width |  | 10 |  | ns |
| Capacitance for Each I/O Pin | $\mathrm{C}_{\mathrm{i}}$ | 5 | 7 | pF |

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## ABSOLUTE MAXIMUM RATINGS

Table 3.

| Parameter | Rating |
| :--- | :--- |
| $\mathrm{V}_{\mathrm{CC}}$ to $\mathrm{V}_{\mathrm{EE}}$ | 3.7 V |
| $\mathrm{DV}_{\mathrm{CC}}$ to $\mathrm{V}_{\mathrm{EE}}$ | 3.7 V |
| $\mathrm{~V}_{\mathrm{TTI}}$ | Lower of $\left(\mathrm{V}_{\mathrm{CC}}+0.6 \mathrm{~V}\right)$ or 3.6 V |
| $\mathrm{~V}_{\mathrm{TTO}}$ | Lower of $(\mathrm{V} \mathrm{CC}+0.6 \mathrm{~V})$ or 3.6 V |
| $\mathrm{~V}_{\mathrm{CC}}$ to $\mathrm{DV} \mathrm{VCC}_{\mathrm{CC}}$ | 0.6 V |
| Internal Power Dissipation | 4.85 W |
| Differential Input Voltage | 2.0 V |
| Logic Input Voltage | $\mathrm{V}_{\mathrm{EE}}-0.3 \mathrm{~V}<\mathrm{V}_{\mathrm{IN}}<\mathrm{V}_{\mathrm{CC}}+0.6 \mathrm{~V}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Junction Temperature | $125^{\circ} \mathrm{C}$ |

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



1. NC = NO CONNECT.
2. THE EXPOSED PAD ON THE BOTTOM OF THE PACKAGE MUST BE

Figure 3. Pin Configuration

Table 4. Pin Function Descriptions

| Pin No. | Mnemonic | Type | Description |
| :---: | :---: | :---: | :---: |
| 1 | SEL4G | Control | Set Transmitter for Low Speed PE, Active High. |
| 2, 15, 29, 33, 47, ePAD | $\mathrm{V}_{\text {EE }}$ | Power | Negative Supply. The exposed pad on the bottom of the package must be electrically connected to $\mathrm{V}_{\mathrm{EE}}$. |
| 3,23,41 | $V_{\text {то }}$ | Power | Port A, Port B, and Port C Output Termination Supply. |
| 4 | ON_A1 | Output | High Speed Output Complement. |
| 5 | OP_A1 | Output | High Speed Output. |
| 6, 12, 26, 37, 40, 44, 55, 59 | Vcc | Power | Positive Supply. |
| 7 | ON_AO | Output | High Speed Output Complement. |
| 8 | OP_A0 | Output | High Speed Output. |
| 9,34,56 | $\mathrm{V}_{\text {TI }}$ | Power | Port A, Port B, and Port C Input Termination Supply. |
| 10 | IN_A1 | Input | High Speed Input Complement. |
| 11 | IP_A1 | Input | High Speed Input. |
| 13 | IN_A0 | Input | High Speed Input Complement. |
| 14 | IP_A0 | Input | High Speed Input. |
| 16 | DV ${ }_{\text {cc }}$ | Power | Digital Power Supply. |
| 17 | SCL | Control | $1^{2} \mathrm{C}$ Clock Input. |
| 18 | SDA | Control | $1^{2} \mathrm{C}$ Data Input/Output. |
| 19 | I2C_A0 | Control | $1^{2} \mathrm{C}$ Address Input (LSB). |
| 20 | I2C_A1 | Control | $1^{2} \mathrm{C}$ Address Input. |
| 21 | I2C_A2 | Control | $1^{2} \mathrm{C}$ Address Input (MSB). |
| 22 | RESET | Control | Device Reset, Active Low. |
| 24 | ON_B1 | Output | High Speed Output Complement. |
| 25 | OP_B1 | Output | High Speed Output. |
| 27 | ON_B0 | Output | High Speed Output Complement. |
| 28 | OP_B0 | Output | High Speed Output. |


| Pin No. | Mnemonic | Type | Description |
| :--- | :--- | :--- | :--- |
| 30 | EQ_A | Control | Port A Equalizer Control Input. |
| 31 | EQ_B | Control | Port B Equalizer Control Input. |
| 32 | EQ_C | Control | Port C Equalizer Control Input. |
| 35 | IN_B1 | Input | High Speed Input Complement. |
| 36 | IP_B1 | Input | High Speed Input. |
| 38 | IN_B0 | Input | High Speed Input Complement. |
| 39 | IP_B0 | Input | High Speed Input. |
| 42 | ON_C1 | Output | High Speed Output Complement. |
| 43 | OP_C1 | Output | High Speed Output. |
| 45 | ON_C0 | Output | High Speed Output Complement. |
| 46 | OP_C0 | Output | High Speed Output. |
| 48 | LB_C | Control | Port A Loopback Control Input, Active High. |
| 49 | LB_B | Control | Port B Loopback Control Input, Active High. |
| 50 | LB_A | Control | Port C Loopback Control Input, Active High. |
| 51 | LOS_INT | Interrupt | Loss of Signal Interrupt, Active High. Initialization sequence |
| 52 | PE_C |  | required; see the Applications Information section. |
| 53 | PE_B | Control | Port A Preemphasis Control Input, Active High. |
| 54 | PE_A | Control | Port B Preemphasis Control Input, Active High. |
| 57 | IN_C1 | Control | Port C Preemphasis Control Input, Active High. |
| 58 | Input | High Speed Input Complement. |  |
| 60 | IN_C0 | Input | High Speed Input. |
| 61 | Input | High Speed Input Complement. |  |
| 62 | SEL1 | Input | High Speed Input. |
| 63 | SEL0 | Control | Lane 1 A/B Switch Control Input. |
| 64 | BICAST | Control | Lane 0 A/B Switch Control Input. |

## TYPICAL PERFORMANCE CHARACTERISTICS



Figure 4. Standard Test Circuit (No Channel)


Figure 5. 6.5 Gbps Input Eye (TP1 from Figure 4)


Figure 6. 6.5 Gbps Output Eye, No Channel (TP2 from Figure 4)

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Figure 8. 6.5 Gbps Input Eye, 20 Inch FR4 Input Channel (TP2 from Figure 7)


Figure 9. 6.5 Gbps Input Eye, 40 Inch FR4 Input Channel (TP2 from Figure 7)


Figure 10. 6.5 Gbps Output Eye, 20 Inch FR4 Input Channel (TP3 from Figure 7)


Figure 11. 6.5 Gbps Output Eye, 40 Inch FR4 Input Channel (TP3 from Figure 7)



Figure 13. 6.5 Gbps Output Eye, 20 Inch FR4 Input Channel, $P E=0$ (TP3 from Figure 12)


Figure 14. 6.5 Gbps Output Eye, 30 Inch FR4 Input Channel, $P E=0$ (TP3 from Figure 12)


Figure 15. 6.5 Gbps Output Eye, 20 Inch FR4 Input Channel, PE = Best Setting, Default Output Level (TP3 from Figure 12)


Figure 16. 6.5 Gbps Output Eye, 30 Inch FR4 Input Channel, PE = Best Setting, 200 mV Output Level (TP3 from Figure 12)

## AD8155



Figure 17. Deterministic Jitter vs. Data Rate


Figure 18. Deterministic Jitter vs. Input Swing


Figure 19. Deterministic Jitter vs. Temperature


Figure 20. Deterministic Jitter vs. Input Common Mode


Figure 21. Deterministic Jitter vs. Vcc


Figure 22. Deterministic Jitter vs. Output Termination Voltage ( $V_{\text {то }}$ )


Figure 23. Deterministic Jitter vs. Output Common-Mode Voltage (V осм)


Figure 24. Random Jitter Histogram


Figure 25. $t_{R} / t_{F}$ vs. Temperature


Figure 26. Output Amplitude (Default Setting) vs. Vcc


Figure 27. Output Amplitude vs. Rate


Figure 28. Propagation Delay vs. Core Supply

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Figure 29. Propagation Delay vs. Temperature


Figure 30. Deterministic Jitter vs. EQ Setting


Figure 31. Random Jitter vs. EQ Setting vs. Trace


Figure 32. Deterministic Jitter vs. PE Setting


Figure 33. Random Jitter vs. PE Setting


Figure 34. S21 Test Traces

## THEORY OF OPERATION

The AD8155 is a buffered, asynchronous, three-port transceiver that allows 2:1 multiplexing and 1:2 demultiplexing among its ports. The 1:2 demux path supports bicast operation, allowing the AD8155 to operate as a port replicator as well as a redundancy switch. The AD8155 offers loopback on each lane, allowing the part to be configured as a six-lane equalizer or redriver with FFE.


Figure 35. Mux/Demux Paths, Port A to Port C
The part offers extensively programmable transmit output levels and preemphasis settings as well as squelch or full disable. The receivers integrate a programmable, multizero transfer function for aggressive equalization and a programmable loss-of-signal feature. The AD8155 provides a balanced, high speed switch core that maintains low lane-to-lane skew while preserving edge rates.

The I/O on-chip termination resistors are tied to user-settable supplies for increased flexibility. The AD8155 supports a wide primary supply range; $\mathrm{V}_{\mathrm{CC}}$ can be set from 1.8 V to 3.3 V . These
features, together with programmable transmitter output levels, allow for a wide range of dc- and ac-coupled I/O configurations.

The AD8155 supports several control and configuration modes, shown in Table 5. The pin control mode offers access to a subset of the total feature list but allows for a much simplified control scheme. Table 6 compares the features in all control modes.

The primary advantage of using the serial control interface is that it allows finer resolution in setting receive equalization, transmitter preemphasis, loss-of-signal (LOS) behavior, and output levels.

By default, the AD8155 starts in the pin control mode. Strobing the $\overline{\text { RESET }}$ pin sets all on-chip registers to their default values and uses pins to configure switch connectivity, PE, and EQ levels. In mixed mode, switch connectivity is still controlled through the SEL[1:0], LB_[A:C], and BICAST pins. The user can override PE and EQ settings in mixed mode. In serial mode, all functions are accessed through registers and the control pin inputs are ignored, except RESET .

The AD8155 register set is controlled through a 2 -wire $\mathrm{I}^{2} \mathrm{C}$ interface. The AD8155 acts only as an $\mathrm{I}^{2} \mathrm{C}$ slave device. The 7 -bit slave address for the AD8155 $\mathrm{I}^{2} \mathrm{C}$ interface contains the static value b1010 for the upper four bits. The lower three bits are controlled by the input pins, I2C_A[2:0].

Table 5. Control Interface Mode Register

| Address | Default | Register Name | Bit | Bit Name | Functionality Description |
| :--- | :--- | :--- | :--- | :--- | :--- |
| 0x0F | $0 \times 00$ | Control | $7: 2$ | Reserved | Set to 0. |
|  |  | interface mode | $1: 0$ | Mode[1:0] | 00: toggle pin control. Asynchronous control through toggle pins only. <br> 10: mixed control. Switch configuration via toggle pins, register-based <br> control through the $I^{2} C$ serial interface. |
|  |  |  |  |  |  |
|  |  |  |  |  |  |
|  |  |  |  | serial control. Register-based control through the $I^{2} C$ serial interface. |  |.

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Table 6. Features Available Through Toggle Pin or Serial Control

| Feature | Pin Control | Serial Control |
| :--- | :--- | :--- |
| Switch Features |  |  |
| BICAST | One pin | One bit |
| A/B Lane Select | Two pins | Two bits |
| Loopback | Three pins | Three bits |
| Rx Features |  |  |
| EQ Levels | Two settings | 10 settings |
| N/P Swap | Not available | Available |
| Squelch | Enabled | Three bits |
| Tx Features |  |  |
| Programmable Output Levels | $\pm 400$ mV diff fixed ${ }^{1}$ | $\pm 200 \mathrm{mV}$ diff $/ \pm 300 \mathrm{mV}$ diff $/ \pm 400 \mathrm{mV}$ diff $/ \pm 600 \mathrm{mV}$ diff |
| PE Levels | Two settings | $>7$ settings |

${ }^{1} \pm 400 \mathrm{mV}$ diff indicates a 400 mV amplitude signal measured between two differential nodes. The voltage swing at differential I/O pins is described in this data sheet both in terms of the differentially measured voltage range ( $\pm 400 \mathrm{mV}$ diff, for example) and in terms of peak-to-peak differential swing, denoted as mV p-p diff. An output level setting of $\pm 400 \mathrm{mV}$ diff delivers a differential peak-to-peak output voltage of 800 mV p-p diff.

## THE SWITCH <br> (MUX/DEMUX/UNICAST/BICAST/LOOPBACK)

The mux and demux functions of the AD8155 can be controlled either with the toggle pins or through the register map. The multiplexer path switches received data from Input Port A or Input Port B to Output Port C. The SEL[1:0] pins allow switching lanes independently. The demultiplexer path switches received data from Input Port C to Output Port A, Output Port B, or (if bicast mode is enabled) to both Output Port A and Output Port B.

Table 7. Port Selection and Configuration with All Loopbacks Disabled

| BICAST | SELx | Output <br> Port A | Output <br> Port B | Output <br> Port C |
| :--- | :--- | :--- | :--- | :--- |
| 0 | 0 | Ix_C[1:0] | Idle | Ix_A[1:0] |
| 0 | 1 | Idle | Ix_C[1:0] | Ix_B[1:0] |
| 1 | 0 | Ix_C[1:0] | Ix_C[1:0] | Ix_A[1:0] |
| 1 | 1 | Ix_C[1:0] | Ix_C[1:0] | Ix_B[1:0] |

When the device is in unicast mode, the output lanes on either Port A or Port B are in an idle state. In the idle state, the transmitter output current is set to 0 , and the P and N sides of the lane are pulled up to the output termination voltage through the on-chip termination resistors. To save power, the unused receiver automatically disables.

The AD8155 supports port-level loopback, illustrated in Figure 36. The loopback control pins override the lane select (SEL[1:0]) and bicast control (BICAST) pin settings at the port level. In serial control mode, Bits [6:4] of Register 0x01 control loopback and are equivalent to asserting Pin LB_A, Pin LB_B, and Pin LB_C. Table 8 summarizes the different loopback configurations.

The loopback feature is useful for system debug, self-test, and initialization, allowing system ASICs to compare Tx and Rx data sent over a single bidirectional link. Loopback can also be used to configure the device as a two- to six-lane receive equalizer or backplane redriver.


Figure 36. Port-Level Loopback
Table 8. Switch Connectivity vs. Loopback, BICAST, and Port Select Settings

| LB_A | LB_B | LB_C | BICAST | SEL[1:0] | Output Port A | Output Port B | Output Port C |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 00 | Ix_C[1:0] | Idle | Ix_A 11:0] |
| 0 | 0 | 0 | 0 | 11 | Idle | Ix_C[1:0] | Ix_B[1:0] |
| 0 | 0 | 0 | 1 | 00 | Ix_C[1:0] | Ix_C[1:0] | Ix_A $1: 0]$ |
| 0 | 0 | 0 | 1 | 1 | Ix_C[1:0] | Ix_C[1:0] | Ix_B[1:0] |
| 0 | 0 | 1 | 0 | 00 | Ix_C[1:0] | Idle | Ix_C[1:0] |
| 0 | 0 | 1 | 0 | 11 | Idle | Ix_C[1:0] | Ix_C $1: 0]$ |
| 0 | 0 | 1 | 1 | 00 | Ix_C[1:0] | Ix_C[1:0] | Ix_C $1: 0]$ |
| 0 | 0 | 1 | 1 | 11 | Ix_C[1:0] | Ix_C[1:0] | Ix_C[1:0] |
| 0 | 1 | 0 | 0 | 00 | Ix_C[1:0] | Ix_B[1:0] | Ix_A $1: 0]$ |
| 0 | 1 | 0 | 0 | 11 | Idle | Ix_B[1:0] | Ix_B[1:0] |
| 0 | 1 | 0 | 1 | 00 | Ix_C[1:0] | Ix_B[1:0] | Ix_A $1: 0]$ |
| 0 | 1 | 0 | 1 | 11 | Ix_C[1:0] | Ix_B[1:0] | Ix_B[1:0] |
| 0 | 1 | 1 | 0 | 00 | Ix_C[1:0] | Ix_B[1:0] | Ix_C $1: 0]$ |
| 0 | 1 | 1 | 0 | 11 | Idle | Ix_B[1:0] | Ix_C $1: 0]$ |
| 0 | 1 | 1 | 1 | 00 | Ix_C[1:0] | Ix_B[1:0] | Ix_C[1:0] |
| 0 | 1 | 1 | 1 | 11 | Ix_C[1:0] | Ix_B[1:0] | Ix_C $1: 0]$ |
| 1 | 0 | 0 | 0 | 00 | Ix_A $1: 0]$ | Idle | Ix_A $1: 0]$ |
| 1 | 0 | 0 | 0 | 11 | Ix_A $1: 0]$ | Ix_C [1:0] | Ix_B $1: 0]$ |
| 1 | 0 | 0 | 1 | 00 | Ix_A[1:0] | Ix_C[1:0] | Ix_A $1: 0]$ |
| 1 | 0 | 0 | 1 | 11 | Ix_A $1: 0]$ | Ix_C[1:0] | Ix_B[1:0] |
| 1 | 0 | 1 | 0 | 00 | Ix_A $1: 0]$ | Idle | Ix_C[1:0] |
| 1 | 0 | 1 | 0 | 11 | Ix_A $1: 0]$ | Ix_C[1:0] | Ix_C[1:0] |
| 1 | 0 | 1 | 1 | 00 | Ix_A $1: 0]$ | Ix_C $1: 0]$ | Ix_C $1: 0]$ |
| 1 | 0 | 1 | 1 | 11 | Ix_A $1: 0]$ | Ix_C[1:0] | Ix_C[1:0] |
| 1 | 1 | 0 | 0 | 00 | Ix_A $1: 0]$ | Ix_B[1:0] | Ix_A[1:0] |
| 1 | 1 | 0 | 0 | 11 | Ix_A[1:0] | Ix_B[1:0] | Ix_B[1:0] |
| 1 | 1 | 0 | 1 | 00 | Ix_A[1:0] | Ix_B[1:0] | Ix_A $1: 0]$ |
| 1 | 1 | 0 | 1 | 11 | Ix_A[1:0] | Ix_B[1:0] | Ix_B[1:0] |
| 1 | 1 | 1 | 0 | 00 | Ix_A[1:0] | Ix_B[1:0] | Ix_C[1:0] |
| 1 | 1 | 1 | 0 | 11 | Ix_A $1: 0]$ | Ix_B[1:0] | Ix_C $1: 0]$ |
| 1 | 1 | 1 | 1 | 00 | Ix_A $1: 0]$ | Ix_B[1:0] | Ix_C $1: 0]$ |
| 1 | 1 | 1 | 1 | 11 | Ix_A[1:0] | Ix_B[1:0] | Ix_C[1:0] |

## RECEIVERS

The AD8155 receivers incorporate $50 \Omega$ on-chip termination, ESD protection, and a multizero equalization function capable of delivering up to 18 dB of boost at 4.25 GHz . The AD8155 can compensate signal degradation at 6.5 Gbps from over 40 inches of FR4 backplane trace. The receive path also incorporates a loss-of-signal (LOS) function that squelches the associated transmitter when the midband differential voltage falls below a specified threshold value. Finally, the receivers implement a signswapping option ( $\mathrm{P} / \mathrm{N}$ swap), which allows the user to invert the sign of the input signal path and eliminates the need for boardlevel crossovers in the receive channels.

## Input Structure and Allowed Input Levels

The AD8155 tolerates an input common-mode range (measured with zero differential input) of

$$
V_{E E}+0.6 \mathrm{~V}<V_{I C M}<V_{C C}+0.3 \mathrm{~V}
$$

Typical supply configurations include, but are not limited to, those listed in Table 9.

Table 9. Typical Input Supply Configurations

| Configuration | DV ${ }_{\text {cc }}$ | Vcc | $\mathrm{V}_{\text {TTI }}$ |
| :---: | :---: | :---: | :---: |
| Low $\mathrm{V}_{\text {тו }}$, AC-Coupled Input | $3.3 \mathrm{~V}-1.8 \mathrm{~V}$ | 1.8 V | 1.6 V |
| Single 1.8V Supply | $3.3 \mathrm{~V}-1.8 \mathrm{~V}$ | 1.8 V | 1.8 V |
| 3.3V Core | 3.3 V | 3.3 V | 1.8 V |
| Single 3.3V Supply | 3.3 V | 3.3 V | 3.3 V |

When dc-coupling with LVDS, CML, or ECL signals, it can be advantageous to operate with split or negative supplies (see the Applications Information section). In these applications, it is necessary to observe the maximum voltage ratings between VCC and $\mathrm{V}_{\mathrm{ee}}$ and to select supply voltages for $\mathrm{V}_{\text {тто }}$ and $\mathrm{V}_{\text {tтi }}$ in the range of $\mathrm{V}_{\mathrm{CC}}$ to $\mathrm{V}_{\mathrm{EE}}$ to avoid activating the ESD protection devices.


Figure 37. Simplified Receiver Input Structure

## Equalizer Settings

Every input lane offers a low power, asynchronous, programmable receive equalizer for NRZ data up to 6.5 Gbps . The pin control interface allows two levels of receive equalization. Register-based control allows the user 10 equalizer settings. Register and pin control boost settings are listed in Table 10. Equalization capability and resulting jitter performance are illustrated in Figure 30, Figure 31, and Figure 34. Figure 34 shows the loss characteristic of various reference channels, and Figure 30 and Figure 31 show resulting DJ and RJ performance vs. equalizer setting against these channels.

The two LSBs of Register 0x41, Register 0x81, and Register 0xC1 allow programming of all the equalizers in a port simultaneously (see Table 13). The $0 \times 42,0 \times 82$, and $0 \times 2$ registers allow per-lane programming of the equalizers (see Table 22). Be aware that writing to the port-level equalizer registers updates and overwrites per-lane settings.

Table 10. Equalizer Settings

| Equalization Boost (dB) | EQ Register Setting | EQ Pin |
| :--- | :--- | :--- |
| 0 | 0 | 0 |
| 2 | 1 | N/A |
| 4 | 2 | N/A |
| 6 | 3 | N/A |
| 8 | 4 | 1 |
| 10 | 5 | N/A |
| 12 | 6 | N/A |
| 14 | 7 | N/A |
| 16 | 8 | N/A |
| 18 | 9 | N/A |



Figure 38. Functional Diagram of the AD8155 Receiver

## Lane Disables

By default, the receivers and transmitters enable in an on-demand fashion according to the state of the SEL[1:0], LB_[A:C], and BICAST pins or to the state of the equivalent registers in serial control mode. Register 0x40, Register 0x80, and Register 0xC0 implement per-lane disables for the receivers, and Register 0x48, Register 0x88, and Register 0xC8 implement per-lane transmitter disables. These disables override the default settings. Each bit in the register is named for the lane and function it disables. For example, RXDIS B0 disables the receiver on Lane 0 of Port B whereas TXDIS C1 disables the Lane 1 transmitter of Port C (see Table 11).

## Lane Inversion: P/N Swap

The receiver $\mathrm{P} / \mathrm{N}$ swap function is a convenience intended to allow the user to implement the equivalent of a board-level routing crossover in a much smaller area while eliminating vias (impedance discontinuities) that compromise the high frequency integrity of the signal path. Using this feature to correct an inversion downstream of the receiver may require the user to be aware of the sign of the data when switching connectivity (the mux/demux path). The feature is available on a per-lane setting through Register 0x44, Register 0x84, and Register 0xC4. Setting the bit true flips the sign sense of the P and N inputs for the associated lane. The default setting is 0 (no inversion).

Table 11. Per-Lane Disables

| Address | Port | Default | Register Name | Bit | Bit Name | Functionality Description |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \hline 0 \times 40 \\ & 0 \times 80 \\ & 0 \times C 0 \end{aligned}$ | Port A <br> Port B <br> Port C | $\begin{aligned} & \hline 0 \times 00 \\ & 0 \times 00 \\ & 0 \times 00 \end{aligned}$ | RX[A/B/C] disable | $\begin{aligned} & \hline 7: 4 \\ & 3: 2 \\ & 1 \\ & \\ & 0 \end{aligned}$ | Reserved <br> Reserved <br> RXDIS [A/B/C]1 <br> RXDIS [A/B/C]0 | Set to 0 <br> 0 : RX Port $[A / B / C]$, Lane 1 , enabled <br> 1: RX Port [A/B/C], Lane 1, disabled <br> 0 : RX Port $[A / B / C]$, Lane 0 , enabled <br> 1: RX Port [A/B/C], Lane 0, disabled |
| $\begin{aligned} & \hline 0 \times 48 \\ & 0 \times 88 \\ & 0 \times C 8 \end{aligned}$ | Port A Port B <br> Port C | $\begin{aligned} & \hline 0 \times 00 \\ & 0 \times 00 \\ & 0 \times 00 \end{aligned}$ | TX[A/B/C] disable | $\begin{aligned} & \hline 7: 4 \\ & 3: 2 \\ & 1 \\ & \\ & 0 \end{aligned}$ | Reserved <br> Reserved <br> TXDIS [A/B/C]1 <br> TXDIS [A/B/C]0 | Set to 0 <br> 0: TX Port [A/B/C], Lane 1, enabled <br> 1: TX Port [A/B/C], Lane 1, disabled <br> 0 : TX Port [A/B/C], Lane 0 , enabled <br> 1: TX Port [A/B/C], Lane 0, disabled |

Table 12. Lane Inversion

| Address | Port | Default | Register Name | Bit | Bit Name | Functionality Description |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $0 \times 44$ | Port A | $0 \times 00$ | RX[A/B/C] P/N swap | $7: 2$ | Reserved | Set to 0 |
| $0 \times 84$ | Port B | $0 \times 00$ |  | 1 | PN[A/B/C]1 | 0: Lane 1, noninverted |
| $0 \times C 4$ | Port C | $0 \times 00$ |  | 0 | PN[A/B/C]0 | 1: Lane 1, inverted <br> 0: Lane 0, noninverted <br> 1: Lane 0, inverted |

Table 13. Port-Level EQ Setting

| Address | Port | Default | Register Name | Bit | Bit Name | Functionality Description |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $0 \times 41$ | Port A | $0 \times 00$ | RX[A/B/C] EQ setting | $7: 4$ | Reserved | Set to 0 |
| $0 \times 81$ | Port B | $0 \times 00$ |  | $3: 0$ | $[A / B / C] E Q[3: 0]$ |  |
| $0 \times C 1$ | Port C | $0 \times 00$ |  |  |  |  |

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## LOSS OF SIGNAL (LOS)

The serial control interface allows access to the AD8155 loss of signal features (LOS is not available in pin control mode). Each receiver includes a low power, loss-of-signal detector. The loss-of-signal circuit monitors the received data stream and generates a system interrupt when the received signal power falls below a fixed threshold. The threshold is 50 mV p-p diff, referred to the input pins. The LOS circuit monitors the equalized receive waveform and integrates the rms power of the equalized waveform over a selectable interval of either 2 ns or 10 ns . The detectors are enabled on a per-port basis with Bit 0 of the RXA/B/C LOS control registers (0x51, 0x91, 0xD1).

By default, when the receiver detects an LOS event, it squelches its associated transmitter, lowering the output current to submicroamps. This prevents the high gain, wide bandwidth signal path from turning low level system noise on an undriven input pair into a source of hostile crosstalk at the transmitter. The squelch feature can be disabled with Bit 3 of the global squelch control register (0x04).

The LOS_INT pin evaluates a logical OR of all LOS status register bits for all enabled receivers (LOS status registers are located at $0 x 45,0 x 85$, and $0 x C 5$ ). The upper two bits in the RXA, RXB, and RXC LOS status registers are sticky, whereas the two LSBs are continuously updated to indicate the instantaneous status of LOS for an enabled receiver. The sticky bits are cleared by writing 0 to the RXA, RXB, and RXC LOS status registers. The LOS_INT pin remains high after an LOS event until all sticky registers are cleared and all active status registers (for example, Bits[1:0]) read 0 . The LOS_INT pin requires that an initialization sequence be enabled (see the Applications Information section).

The LOS_INT pin can be used to generate an interrupt for the system control software. In a standard implementation, when LOS_INT goes high, the system software registers the interrupt and polls the RXA, RXB, and RXC LOS status registers to determine which input lost signal and whether the signal has been restored.

Table 14. Global Loss-of-Signal Squelch Control Register

| Address | Default | Register Name | Bit | Bit Name | Functionality Description |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $0 \times 04$ | $0 \times 0 \mathrm{~F}$ | Global Squelch Ctrl | $7: 4$ | Reserved | Set to 0 |
|  |  |  | 3 | GSQLCH_ENB | 0: LOS auto squelch disabled |
|  |  |  |  |  | 1: LOS auto squelch enabled |
|  |  |  | Reserved | Set to 1 |  |

Table 15. Port-Level Loss-of-Signal Control Registers

| Address | Port | Default | Register Name | Bit | Bit Name | Functionality Description |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $0 \times 51$ | Port A | $0 \times 05$ | RX[A/B/C] LOS | $7: 3$ | Reserved | Set to 0 |
| $0 \times 91$ | Port B | $0 \times 05$ | control | 2 | LOS_FILT | $0:$ LOS filter time constant $=2 \mathrm{~ns}$ |
| 0xD1 | Port C | $0 \times 05$ |  |  | $1:$ LOS filter time constant $=10 \mathrm{~ns}$ |  |
|  |  |  |  | 1 | Reserved | Set to 0 |
|  |  |  |  | 0 | LOS_ENB | $0:$ LOS disabled <br> $1:$ LOS enabled |

Table 16. Port-Level Loss-of-Signal Status Registers

| Address | Port | Default | Register Name | Bit | Bit Name | Functionality Description |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $0 \times 45$ | Port A | Read only |  | $7: 6$ | Reserved |  |
| 0x85 | Port B | Write 0 to clear | RX[A/B/C] LOS | $5: 4$ | LOS[A/B/C][1:0] <br> SxC5 | Port C |

## TRANSMITTERS

The AD8155 transmitter offers programmable preemphasis, programmable output levels, output disable, and transmit squelch. The SEL4G pin lets the user lower the transmitter frequency of maximum boost from 3.25 GHz to 2.0 GHz , allowing the AD8155 to offer exceptional transmit channel compensation for legacy applications (4.5 Gbps and slower).


Figure 39. Simplified Transmitter Structure

## Output Level Programming and Output Structure

The output level of the transmitter of each lane is independently programmable. In pin control mode, a default output amplitude of 800 mV p-p diff ( $\pm 400 \mathrm{mV}$ diff) is delivered (see Table 17). Register-based control allows the user to set the transmitter output levels on a per-port or per-lane basis to four predefined levels. Port-level programming overwrites lane-level configuration. The ALEV, BLEV, and CLEV bits in Register 0x49, Register 0x89, and Register 0 xC 9 , respectively, are used to set the output levels for all transmitters. The $\mathrm{A}[1: 0] \operatorname{OLEV}[1: 0], \mathrm{B}[1: 0] \operatorname{OLEV}[1: 0]$, and C[1:0]OLEV[1:0] bits in Register 0x4C, Register 0x8C, and Register 0xCC allow per-lane settings (see Table 22).

Table 17. Predefined Output Levels

| [A/B/C][1:0]OLEV[1] | [A/B/C][1:0]OLEV[0] | Output Level |
| :--- | :--- | :--- |
| 0 | 0 | $\pm 200 \mathrm{mV}$ diff |
| 0 | 1 | $\pm 300 \mathrm{mV}$ diff |
| 1 | 0 | $\pm 400 \mathrm{mV}$ diff |
| 1 | 1 | (default) |
|  | $\pm 600 \mathrm{mV}$ diff |  |

Note that the choice of output level influences the output common-mode level. A 600 mV diff output level with a full PE range requires a supply and output termination voltage of 2.5 V or higher ( $\mathrm{V}_{\text {тто }}, \mathrm{V}_{\mathrm{CC}} \geq 2.5 \mathrm{~V}$ ).

## Preemphasis

Transmitter preemphasis levels can be set by pin control or through the control registers. Pin control allows two settings of PE, 0 dB and 6 dB . The control registers provide seven levels of PE. Note that a larger range of boost settings is available for lower output levels. Note that toggle pin control of PE is limited to the 400 mV diff output level settings. Table 18 lists the available preemphasis settings for each output level.

Preemphasis can be programmed per port or per lane. Register 0x49, Register 0x89, and Register 0xC9 set all outputs in a port at once. Registers $0 \mathrm{x} 4 \mathrm{~A}, 0 \mathrm{x} 8 \mathrm{~A}$, and 0 xCA allow setting PE on a per-lane basis. The following equation sets preemphasis boost:

$$
\begin{equation*}
\operatorname{Gain}[d B]=20 \times \log _{10}\left(1+\frac{V_{S W-P E}-V_{S W-D C}}{V_{S W-D C}}\right) \tag{1}
\end{equation*}
$$

Table 18. Setting Transmitter Preemphasis

| Output Level <br> (mV diff) | Pin <br> PE_[A/B/C] | Bit <br> PE[2:0] | PE <br> Boost <br> (\%) | PE Boost <br> (dB) |
| :--- | :--- | :--- | :--- | :--- |
| 200 | N/A | 000 | 0 | 0 |
| 200 | N/A | 001 | 50 | 3.52 |
| 200 | N/A | 010 | 100 | 6.02 |
| 200 | N/A | 011 | 150 | 7.96 |
| 200 | N/A | 100 | 200 | 9.54 |
| 200 | N/A | 101 | 250 | 10.88 |
| 200 | N/A | 110 | 300 | 12.04 |
| 300 | N/A | 000 | 0 | 0 |
| 300 | N/A | 001 | 33 | 2.5 |
| 300 | N/A | 010 | 67 | 4.44 |
| 300 | N/A | 011 | 100 | 6.02 |
| 300 | N/A | 100 | 133 | 7.36 |
| 300 | N/A | 101 | 167 | 8.52 |
| 300 | N/A | 110 | 200 | 9.54 |
| 400 | 0 | 000 | 0 | 0 |
| 400 | N/A | 001 | 25 | 1.94 |
| 400 | N/A | 010 | 50 | 3.52 |
| 400 | N/A | 011 | 75 | 4.86 |
| 400 | 1 | 100 | 100 | 6.02 |
| 400 | N/A | 101 | 125 | 7.04 |
| 400 | N/A | 110 | 150 | 7.96 |
| 600 | N/A | 000 | 0 | 0 |
| 600 | N/A | 001 | 17 | 1.34 |
| 600 | N/A | 010 | 33 | 2.5 |
| 600 | N/A | 011 | 50 | 3.52 |
| 600 | N/A | 100 | 67 | 4.44 |
| 600 | N/A | 101 | 83 | 5.26 |
| 600 | N/A | 110 | 100 | 6.02 |
| 594 |  |  |  |  |

## Squelch and Disable

Each transmitter is equipped with disable and squelch controls. Disable is a full power-down state: the transmitter current is reduced to zero and the output pins pull up to $\mathrm{V}_{\mathrm{TT}}$, but there is a delay of approximately $1 \mu$ sassociated with reenabling the transmitter. Squelch keeps the output current enabled such that both output pins are at the output common-mode voltage. The transmitter recovers from squelch in less than 64 ns .

## Speed Select

The SEL4G pin lets the user lower the transmitter frequency of maximum boost from 3.25 GHz to 2.0 GHz , allowing the AD8155 to offer exceptional transmit channel compensation for legacy applications (4.5 Gbps and slower). SEL4G $=1$ lowers the

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frequency of maximum boost without sacrificing the amount of boost delivered.

## AD8155 POWER CONSUMPTION

There are several sections of the AD8155 that draw varying power depending on the supply voltages, the type of I/O coupling used, and the status of the AD8155 operation. Figure 40 shows a block diagram of these sections. An initialization sequence is required to enable the AD8155 in a low power mode (see the Applications Information section).

The first section consists of the input termination resistors. The power dissipated in the termination resistors is due to the input differential swing and any common-mode current resulting from dc-coupling the input.

In the next section (the receiver section), each input is powered only when it is selected, and the disable bits are set to 0 . If a receiver is not selected, it is powered down. Thus, the total number of active inputs affects the total power consumption. Furthermore, the loss-of-signal detection circuits can be disabled independent of the receiver for even greater power savings.

The core of the device performs the multiplexer and demultiplexer switching functions. It draws a fixed quiescent current of 2 mA whenever the AD8155 is powered from $\mathrm{V}_{\mathrm{CC}}$ to $\mathrm{V}_{\mathrm{fe}}$. The switch draws an additional $4 \times 4.6 \mathrm{~mA}$ in normal mux/demux operation and an additional $6 \times 4.6 \mathrm{~mA}$ with all ports in loopback or with bicast selected. The switch core can be disabled to save power.

An output predriver section draws a current, $\mathrm{I}_{\text {PRED }}$, that is related to the programmed output current, $\mathrm{I}_{\mathrm{T} T \mathrm{o}}$. The predriver current always flows from $\mathrm{V}_{\mathrm{CC}}$ to $\mathrm{V}_{\mathrm{EE}}$. It is treated separately from the output current, which flows from $\mathrm{V}_{\text {тто }}$ and may not be the same voltage as $\mathrm{V}_{\mathrm{CC}}$.

The final section is the outputs section. For an individual output, the programmed output current flows through two separate paths. One is the on-chip termination resistor, and the other is the transmission line and the destination termination resistor. The nominal parallel impedance of these two paths is $25 \Omega$. The sum of these two currents flows through the switches and the current source of the AD8155 output circuit and out through $\mathrm{V}_{\mathrm{fe}}$. The power dissipated in the transmission line and the destination resistor is not dissipated in the AD8155 but must be supplied from the power supply and is a factor in overall system power. The current in the on-chip termination resistors and the output current source dissipate power in the AD8155 itself.

## Outputs

The output current is set by a combination of output level and preemphasis settings (see Table 19). For the two logic switch states, this current flows through an on-chip termination resistor and a parallel path to the destination device and its termination resistor. The power in this parallel path is not dissipated by the AD8155. With preemphasis enabled, some current always flows in both the P and N termination resistors. This preemphasis current gives rise to an output commonmode shift, which varies with ac-coupling or dc-coupling and which is calculated for both cases in Table 19.

Perhaps the most direct method for calculating power dissipated in the output is to calculate the power that would be dissipated if all of $\mathrm{I}_{\text {Tot }}$ were to flow on-die from $\mathrm{V}_{\mathrm{TTO}}$ to $\mathrm{V}_{\mathrm{EE}}$ and to subtract from this the power dissipated off die in the destination device termination resistors and the channel. For this purpose, the destination device and channel can be modeled as $50 \Omega$ load resistors, $\mathrm{R}_{\mathrm{L}}$, in parallel with the AD8155 termination resistors.


Figure 40. AD8155 Power Distribution Block Diagram

## Power Saving Considerations

Whereas the AD8155 power consumption is very low compared to similar devices, careful control of its operating conditions can yield further power savings. Significant power reduction can be realized by operating the part at a lower voltage. Compared to 3.3 V operation, a supply voltage of 1.8 V can result in power savings of $\sim 45 \%$. There is no performance penalty when operting at lower voltage. An initialization sequence is required to enable the AD8155 in a low power mode (see the Applications Information section).

A second measure is to disable transmitters when they are not being used. This can be done on a static basis if the output is not used or on a dynamic basis if the output does not have a constant stream of traffic. On transmit disable (Register 0x48, Register 0x88, Register 0xC8), both the predriver and output switch currents are disabled. The LOS-activated squelch disables only the output switch current, $\mathrm{I}_{\text {тот. }}$. Superior power
saving is achieved by using the TX and RX disable registers to turn off an unused lane as opposed to relying on the AD8155 transmit squelch feature.

Because the majority of the power dissipated is in the output stage, some of its flexibility can be used to lower the power consumption. First, the output current and output preemphasis settings can be programmed to the smallest amount required to maintain BER performance. If an output circuit always has a short length and the receiver has good sensitivity, then a lower output current can be used.

It is also possible to lower the voltage on $\mathrm{V}_{\text {тто }}$ to lower the power dissipation. The amount that $\mathrm{V}_{\text {тто }}$ can be lowered is dependent on the lowest of all the output's $V_{\text {ol }}$ and $V_{\text {cc. }}$. This is determined by the output that is operating at the highest programmed output current. Table 1 and Table 19 list minimum output levels.

## I 12 C CONTROL INTERFACE

## SERIAL INTERFACE GENERAL FUNCTIONALITY

The AD8155 register set is controlled through a 2 -wire $\mathrm{I}^{2} \mathrm{C}$ interface. The AD8155 acts only as an $\mathrm{I}^{2} \mathrm{C}$ slave device. The 7-bit slave address for the AD8155 I2C interface contains the static value b1010 for the upper four bits. The lower three bits are controlled by the input pins, I2C_A[2:0].

Therefore, the $\mathrm{I}^{2} \mathrm{C}$ bus in the system must include an $\mathrm{I}^{2} \mathrm{C}$ master to configure the AD8155 and other $\mathrm{I}^{2} \mathrm{C}$ devices that may be on the bus. Data transfers are controlled through the use of the two $\mathrm{I}^{2} \mathrm{C}$ wires: the SCL input clock pin and the SDA bidirectional data pin.

The AD8155 I ${ }^{2} \mathrm{C}$ interface can be run in the standard ( 64 kHz ) and fast ( 400 kHz ) modes. The SDA line changes value only when the SCL pin is low, with two exceptions. To indicate the beginning or continuation of a transfer, the SDA pin is driven low while the SCL pin is high, and to indicate the end of a transfer, the SDA line is driven high while the SCL line is high. Therefore, it is important to control the SCL clock to toggle only when the SDA line is stable unless indicating a start, repeated start, or stop condition.

## I²C INTERFACE DATA TRANSFERS: DATA WRITE

To write data to the AD8155 register set, a microcontroller or any other $\mathrm{I}^{2} \mathrm{C}$ master must send the appropriate control signals to the AD8155 slave device. The following steps must be taken, where the signals are controlled by the $\mathrm{I}^{2} \mathrm{C}$ master, unless otherwise specified. For a diagram of the procedure, see Figure 41.

1. Send a start condition (while holding the SCL line high, pull the SDA line low).
2. Send the AD8155 part address (seven bits) whose upper four bits are the static value b1010 and whose lower three bits are controlled by the I2C_A[2:0] input pins. This transfer should be MSB first.
3. Send the write indicator bit (0).
4. Wait for the AD8155 to acknowledge the request.
5. Send the register address (eight bits) to which data is to be written. This transfer should be MSB first.
6. Wait for the AD8155 to acknowledge the request.
7. Send the data (eight bits) to be written to the register whose address was set in Step 5. This transfer should be MSB first.
8. Wait for the AD8155 to acknowledge the request.
9. Do one or more of the following:
a. Send a stop condition (while holding the SCL line high, pull the SDA line high) and release control of the bus.
b. Send a repeated start condition (while holding the SCL line high, pull the SDA line low) and continue with Step 2 in this procedure to perform another write.
c. Send a repeated start condition (while holding the SCL line high, pull the SDA line low) and continue with Step 2 of the read procedure (in the $\mathrm{I}^{2} \mathrm{C}$ Interface Data Transfers: Data Read section) to perform a read from another address.
d. Send a repeated start condition (while holding the SCL line high, pull the SDA line low) and continue with Step 8 of the read procedure (in the $I^{2} C$ Interface Data Transfers: Data Read section) to perform a read from the same address set in Step 5.

In Figure 41, the AD8155 write process is shown. The SCL signal is shown along with a general write operation and a specific example. In this example, the value $0 \times 92$ is written to Address 0x6D of an AD8155 device with a part address of $0 \times 53$. The part address is seven bits wide and is composed of the AD8155 static upper four bits (b1010) and the pin-programmable lower three bits (I2C_A[2:0]). The address pins are set to b011. In Figure 41, the corresponding step number is visible in the circle under the waveform. The SCL line is driven by the $\mathrm{I}^{2} \mathrm{C}$ master and never by the AD8155 slave. As for the SDA line, the data in the shaded polygons is driven by the AD8155, whereas the data in the nonshaded polygons is driven by the $\mathrm{I}^{2} \mathrm{C}$ master. The end phase case shown is that of Step 9a.

It is important to note that the SDA line changes only when the SCL line is low, except for the case of sending a start, stop, or repeated start condition (Step 1 and Step 9 in this case).


Figure 41. ${ }^{1}$ C Write Diagram

## $I^{2} \mathrm{C}$ INTERFACE DATA TRANSFERS: DATA READ

To read data from the AD8155 register set, a microcontroller or any other $\mathrm{I}^{2} \mathrm{C}$ master must send the appropriate control signals to the AD8155 slave device. The following steps must be taken, where the signals are controlled by the $\mathrm{I}^{2} \mathrm{C}$ master, unless otherwise specified. For a diagram of the procedure, see Figure 42.

1. Send a start condition (while holding the SCL line high, pull the SDA line low).
2. Send the AD8155 part address (seven bits) whose upper four bits are the static value b1010 and whose lower three bits are controlled by the I2C_A[2:0] input pins. This transfer should be MSB first.
3. Send the write indicator bit (0).
4. Wait for the AD8155 to acknowledge the request.
5. Send the register address (eight bits) from which data is to be read. This transfer should be MSB first. The register address is kept in memory in the AD8155 until the part is reset or the register address is written over with the same procedure (Step 1 to Step 6).
6. Wait for the AD8155 to acknowledge the request.
7. Send a repeated start condition (while holding the SCL line high, pull the SDA line low).
8. Send the AD8155 part address (seven bits) whose upper four bits are the static value b1010 and whose lower three bits are controlled by the I2C_A [2:0] input pins. This transfer should be MSB first.
9. Send the read indicator bit (1).
10. Wait for the AD8155 to acknowledge the request.
11. The AD8155 then serially transfers the data (eight bits) held in the register indicated by the address set in Step 5.
12. Acknowledge the data.
13. Do one or more of the following:
a. Send a stop condition (while holding the SCL line high, pull the SDA line high) and release control of the bus.
b. Send a repeated start condition (while holding the SCL line high, pull the SDA line low) and continue with Step 2 of the write procedure (see the $\mathrm{I}^{2} \mathrm{C}$ Interface Data Transfers: Data Write section) to perform a write.
c. Send a repeated start condition (while holding the SCL line high, pull the SDA line low) and continue with Step 2 of this procedure to perform a read from another address.
d. Send a repeated start condition (while holding the SCL line high, pull the SDA line low) and continue with Step 8 of this procedure to perform a read from the same address.

In Figure 42, the AD8155 read process is shown. The SCL signal is shown along with a general read operation and a specific example. In this example, the value $0 \times 49$ is read from Address $0 \times 6 \mathrm{D}$ of an AD8155 device with a $0 x 53$ part address. The part address is seven bits wide and is composed of the AD8155 static upper four bits (b1010) and the pin-programmable lower three bits (I2C_A[2:0]). The address pins are set to b011. In Figure 42, the corresponding step number is visible in the circle under the waveform. The SCL line is driven by the $\mathrm{I}^{2} \mathrm{C}$ master and never by the AD8155 slave. As for the SDA line, the data in the shaded polygons is driven by the AD8155, whereas the data in the nonshaded polygons is driven by the $\mathrm{I}^{2} \mathrm{C}$ master. The end phase case shown is that of Step 13a.

It is important to note that the SDA line changes only when the SCL line is low, except for the case of sending a start, stop, or repeated start condition, as in Step 1, Step 7, and Step 13. In Figure 42, A is the same as ACK. Equally, Sr represents a repeated start where the SDA line is brought high before SCL is raised. SDA is then dropped while SCL is still high.


## AD8155

## APPLICATIONS INFORMATION

The main application of the AD8155 is to support redundancy on both the backplane side and the line interface side of a serial link. Each port consists of four lanes to support standards such as RXAUI. Figure 43 illustrates redundancy in an RXAUI backplane system. Each line card is connected to two switch fabrics (primary and redundant). The device can be configured
to support either $1+1$ or 1:1 redundancy. Also, the AD8155 can enable module redundancy, as shown in Figure 44, and can be used as a four- or six-lane signal conditioning device to enable high speed serial communication over long copper links.


Figure 43. Using the AD8155 for Switch Redundancy


Figure 44. Using the AD8155 for Module Redundancy


Figure 45. Using the AD8155 for Signal Conditioning

## OUTPUT COMPLIANCE

In low voltage applications, users must pay careful attention to both the differential and common-mode signal levels. The choice of output voltage swing, preemphasis setting, supply voltages ( $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\text {тто }}$ ), and output coupling (ac or dc) affect peak and settled single-ended voltage swings and the commonmode shift measured across the output termination resistors. These choices also affect output current and, consequently, power consumption. For certain combinations of supply voltage and output coupling, output voltage swing and preemphasis settings may violate the single-ended absolute output low voltage, as specified in Table 1. Under these conditions, the performance is degraded; therefore, these settings are not recommended. Table 19 includes annotations that identify these settings.

Table 19 shows the change in output common mode $\left(\Delta \mathrm{V}_{\text {OCM }}=\right.$ $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\text {оСм }}$ ) with output level ( $\mathrm{V}_{\mathrm{sw}}$ ) and preemphasis setting. Table 19 also shows the minimum and maximum peak singleended output levels ( $\mathrm{V}_{\text {L-PE }}$ and $\mathrm{V}_{\text {H-PE }}$, respectively). The singleended output levels are calculated for $\mathrm{V}_{\text {тTо }}$ supplies of 3.3 V and 1.8 V for both ac- and dc-coupled outputs to illustrate the practical challenges of reducing the supply voltage.

## TX_HEADROOM

For output levels greater than 400 mV diff ( 800 mV p-p diff), setting the TX_HEADROOM bit to 1 allows the transmitter an extra 200 mV of output compliance range. When the TX_ HEADROOM bit is enabled, a core supply voltage, $\mathrm{V}_{\mathrm{CC}} \geq 2.5 \mathrm{~V}$, is required. Enabling TX_HEADROOM increases the core supply current. TX_HEADROOM can be enabled on a per-port basis through Bits[6:4] in Register 0x05. A value of 0 disables the headroom-generating circuitry; a value of 1 enables it.

## Example 1: 1.8 V, PE Disabled

Consider a typical application using pin control mode. In this case, the default output level of 400 mV diff ( 800 mV p-p diff) is selected, and the user can choose preemphasis settings of

0 dB or 6 dB . Table 19 shows that with preemphasis disabled, a dc-coupled transmitter causes a 200 mV common-mode shift across the termination resistors, whereas an ac-coupled transmitter causes twice the common-mode shift. Notice that with $V_{C C}$ and $\mathrm{V}_{\text {тто }}$ powered from a 1.8 V supply, the single-ended output voltage swings between 1.8 V and 1.4 V when dc-coupled and between 1.6 V and 1.2 V when ac-coupled. In both cases, these levels are greater than the minimum $V_{\mathrm{L}}$ limit of 725 mV , and $\mathrm{V}_{\mathrm{CC}}$ satisfies the minimum $V_{C C}$ limit of 1.8 V with the TX_HEADROOM bit set to 0 . Note that setting TX_HEADROOM $=1$ violates the minimum $\mathrm{V}_{\mathrm{CC}}$ limit of 2.5 V .

## Example 2: 1.8 V, PE = 6 dB

With a PE setting of 6.02 dB , the ac-coupled transmitter has single-ended swings from 1.4 V to 0.6 V , whereas the dccoupled transmitter outputs swing between 1.8 V and 1 V . The peak minimum single-ended swing ( $\mathrm{V}_{\mathrm{L}-\mathrm{EE}}$ ) of the ac-coupled transmitter, in this case, exceeds the minimum $V_{L}$ limit of 725 mV by 125 mV . While theoretically in violation of the specification, in practice, this setting is viable, especially at high data rates. The transmitter theoretical peak voltage is rarely achieved in practice because the high frequency characteristic of the preemphasis is attenuated at the output pins by the lowpass nature of the PC board environment and the channel. For 6.5 Gbps PE (SEL4G $=0$ ), a $30 \%$ reduction of overshoot as measured at the PC board is possible. For an output level of 400 mV diff and a PE setting of 6 dB , the user can calculate a maximum overshoot of 400 mV diff but can measure only a 270 mV overshoot. With the preemphasis configured for 4.25 Gbps operation (SEL4G = 1), the measured overshoot more closely matches the theoretical maximum. In this case, the peak minimum voltage limit should be more closely observed.

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SIGNAL LEVELS AND COMMON-MODE SHIFT FOR AC-COUPLED AND DC-COUPLED OUTPUTS
Table 19. Output Voltage Range and Output Common-Mode Shift vs. Output Level and PE Setting

| Output Levels and PE Boost |  |  |  | Register Setting <br> TX[A/B/C] Level/PE Control ${ }^{2}$ | Output Current$\mathrm{I}_{\text {тто }}{ }^{1}(\mathrm{~mA})$ | AC-Coupled Transmitter |  |  |  |  | DC-Coupled Transmitter |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\text {то }}=3.3 \mathrm{~V}$ |  | $\mathrm{V}_{\mathrm{cc}}=\mathrm{V}_{\text {то }}=\mathbf{1 . 8} \mathrm{V}$ |  |  | $\mathrm{V}_{\mathrm{cc}}=\mathrm{V}_{\text {T\% }}=3.3 \mathrm{~V}$ |  | $\mathrm{V}_{\mathrm{cc}}=\mathrm{V}_{\text {то }}=1.8 \mathrm{~V}$ |  |
| $\begin{aligned} & V_{\mathrm{SW}-\mathrm{DC}}{ }^{1} \\ & (\mathrm{mV}) \\ & \hline \end{aligned}$ | $\begin{aligned} & V_{S W-P E}^{1} \\ & (\mathbf{m V}) \end{aligned}$ | PE <br> Boost <br> (\%) | PE (dB) |  |  | $\Delta V_{\text {ocm }}{ }^{1}$ (mV) | $\begin{aligned} & \mathbf{V}_{\mathrm{H}-\mathrm{PE}}{ }^{1} \\ & (\mathrm{~V}) \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathbf{V}_{\mathrm{L}-\mathrm{PE}}{ }^{1} \\ & \mathbf{( V )} \end{aligned}$ | $\begin{aligned} & \mathbf{V}_{\mathrm{H}-\mathrm{PE}}{ }^{1} \\ & (\mathrm{~V}) \end{aligned}$ | $\begin{aligned} & \mathbf{V}_{\mathrm{LPEE}^{1}} \\ & \mathbf{( V )} \\ & \hline \end{aligned}$ | $\Delta \mathbf{V O c m}^{1}$ <br> (mV) | $\begin{aligned} & \mathbf{V}_{\mathrm{H}-\mathrm{PE}}{ }^{1} \\ & (\mathrm{~V}) \end{aligned}$ | $\begin{aligned} & \mathbf{V}_{\mathrm{L}_{\mathrm{PE}}{ }^{1}} \\ & \mathbf{V}) \end{aligned}$ | $\begin{array}{\|l\|} V_{\mathrm{H}-\mathrm{PE}}{ }^{1} \\ (\mathrm{~V}) \\ \hline \end{array}$ | $\begin{aligned} & V_{\mathrm{L}_{\mathrm{LPE}}{ }^{1}} \\ & \text { (V) } \end{aligned}$ |
| 200 | 200 | 0.00 | 0.00 |  | 0x00 | 8 | 200 | 3.2 | 3 | 1.7 | 1.5 | 100 | 3.3 | 3.1 | 1.8 | 1.6 |
| 200 | 300 | 50.00 | 3.52 | $0 \times 01$ | 12 | 300 | 3.15 | 2.85 | 1.65 | 1.35 | 150 | 3.3 | 3 | 1.8 | 1.5 |
| 200 | 400 | 100.00 | 6.02 | $0 \times 02$ | 16 | 400 | 3.1 | 2.7 | 1.6 | 1.2 | 200 | 3.3 | 2.9 | 1.8 | 1.4 |
| 200 | 500 | 150.00 | 7.96 | $0 \times 03$ | 20 | 500 | 3.05 | 2.55 | 1.55 | 1.05 | 250 | 3.3 | 2.8 | 1.8 | 1.3 |
| 200 | 600 | 200.00 | 9.54 | 0x04 | 24 | 600 | 3 | 2.4 | 1.5 | 0.9 | 300 | 3.3 | 2.7 | 1.8 | 1.2 |
| 200 | 700 | 250.00 | 10.88 | $0 \times 05$ | 28 | 700 | 2.95 | 2.25 | 1.45 | 0.75 | 350 | 3.3 | 2.6 | 1.8 | 1.1 |
| 200 | 800 | 300.00 | 12.04 | 0x06 | 32 | 800 | 2.9 | 2.1 | 1.4 | 0.6 | 400 | 3.3 | 2.5 | 1.8 | 1 |
| 300 | 300 | 0.00 | 0.00 | 0x10 | 12 | 300 | 3.15 | 2.85 | 1.65 | 1.35 | 150 | 3.3 | 3 | 1.8 | 1.5 |
| 300 | 400 | 33.33 | 2.50 | 0x11 | 16 | 400 | 3.1 | 2.7 | 1.6 | 1.2 | 200 | 3.3 | 2.9 | 1.8 | 1.4 |
| 300 | 500 | 66.67 | 4.44 | 0x12 | 20 | 500 | 3.05 | 2.55 | 1.55 | 1.05 | 250 | 3.3 | 2.8 | 1.8 | 1.3 |
| 300 | 600 | 100.00 | 6.02 | $0 \times 13$ | 24 | 600 | 3 | 2.4 | 1.5 | 0.9 | 300 | 3.3 | 2.7 | 1.8 | 1.2 |
| 300 | 700 | 133.33 | 7.36 | 0x14 | 28 | 700 | 2.95 | 2.25 | 1.45 | 0.75 | 350 | 3.3 | 2.6 | 1.8 | 1.1 |
| 300 | 800 | 166.67 | 8.52 | $0 \times 15$ | 32 | 800 | 2.9 | 2.1 | 1.4 | 0.6 | 400 | 3.3 | 2.5 | 1.8 | 1 |
| 300 | 900 | 200.00 | 9.54 | 0x16 | 36 | 900 | 2.85 | 1.95 | 1.35 | 0.45 | 450 | 3.3 | 2.4 | 1.8 | 0.9 |
| 400 | 400 | 0.00 | 0.00 | 0x20 | 16 | 400 | 3.1 | 2.7 | 1.6 | 1.2 | 200 | 3.3 | 2.9 | 1.8 | 1.4 |
| 400 | 500 | 25.00 | 1.94 | $0 \times 21$ | 20 | 500 | 3.05 | 2.55 | 1.55 | 1.05 | 250 | 3.3 | 2.8 | 1.8 | 1.3 |
| 400 | 600 | 50.00 | 3.52 | $0 \times 22$ | 24 | 600 | 3 | 2.4 | 1.5 | 0.9 | 300 | 3.3 | 2.7 | 1.8 | 1.2 |
| 400 | 700 | 75.00 | 4.86 | $0 \times 23$ | 28 | 700 | 2.95 | 2.25 | 1.45 | 0.75 | 350 | 3.3 | 2.6 | 1.8 | 1.1 |
| 400 | 800 | 100.00 | 6.02 | 0x24 | 32 | 800 | 2.9 | $2.1{ }^{3}$ | 1.4 | 0.6 | 400 | 3.3 | 2.5 | 1.8 | 1 |
| 400 | 900 | 125.00 | 7.04 | 0x25 | 36 | 900 | 2.85 | $1.95{ }^{4}$ | 1.35 | 0.45 | 450 | 3.3 | 2.4 | 1.8 | 0.9 |
| 400 | 1000 | 150.00 | 7.96 | $0 \times 26$ | 40 | 1000 | 2.8 | $1.8{ }^{4}$ | 1.3 | 0.3 | 500 | 3.3 | 2.3 | 1.8 | 0.8 |
| 600 | 600 | 0.00 | 0.00 | 0x30 | 24 | 600 | 3 | 2.4 | 1.5 | 0.9 | 300 | 3.3 | 2.7 | 1.8 | 1.2 |
| 600 | 700 | 16.67 | 1.34 | 0x31 | 28 | 700 | 2.95 | 2.25 | 1.45 | 0.75 | 350 | 3.3 | 2.6 | 1.8 | 1.1 |
| 600 | 800 | 33.33 | 2.50 | 0x32 | 32 | 800 | 2.9 | $2.1{ }^{3}$ | 1.4 | $0.6^{5}$ | 400 | 3.3 | 2.5 | 1.8 | 1 |
| 600 | 900 | 50.00 | 3.52 | 0x33 | 36 | 900 | 2.85 | $1.95{ }^{4}$ | 1.35 | $0.45^{4}$ | 450 | 3.3 | 2.4 | 1.8 | 0.9 |
| 600 | 1000 | 66.67 | 4.44 | 0x34 | 40 | 1000 | 2.8 | $1.8{ }^{4}$ | 1.3 | $0.3^{4}$ | 500 | 3.3 | 2.3 | 1.8 | 0.8 |
| 600 | 1100 | 83.33 | 5.26 | 0x35 | 44 | 1100 | 2.75 | $1.65{ }^{4}$ | 1.25 | $0.15{ }^{4}$ | 550 | 3.3 | 2.2 | 1.8 | 0.7 |
| 600 | 1200 | 100.00 | 6.02 | 0x36 | 48 | 1200 | 2.7 | $1.5^{4}$ | 1.2 | $0^{4}$ | 600 | 3.3 | $2.1{ }^{3}$ | 1.8 | $0.6^{5}$ |

[^1]
## AD8155

Table 20. Symbol Definitions

| Symbol | Formula | Definition |
| :---: | :---: | :---: |
| ldC | Programmable | Output current that sets output level |
| $\mathrm{IPE}^{\text {P }}$ | Programmable | Output current for PE delayed tap |
| Iто | $\mathrm{I}_{\mathrm{DC}}+\mathrm{I}_{\text {PE }}$ | Total transmitter output current |
| $V_{\text {DPP-DC }}$ | $25 \Omega \times \operatorname{loC} \times 2$ | Peak-to-peak differential voltage swing of nonpreemphasized waveform |
| $\mathrm{V}_{\text {DPP-PE }}$ | $25 \Omega \times 1$ то $\times 2$ | Peak-to-peak differential voltage swing of preemphasized waveform |
| Vsw-dc | $\mathrm{V}_{\text {DPP-DC }} / 2=\mathrm{V}_{\mathrm{H}-\mathrm{DC}}-\mathrm{V}_{\text {L-DC }}$ | DC single-ended voltage swing |
| $V_{\text {SW-PE }}$ | $\mathrm{V}_{\text {DPP-PE }} / 2=\mathrm{V}_{\text {H-PE }}-\mathrm{V}_{\text {L-PE }}$ | Preemphasized single-ended voltage swing |
| $\Delta \mathrm{V}_{\text {ocm_de-coupled }}$ | $25 \Omega \times 1{ }_{\text {T\% }} / 2$ | Output common-mode shift, dc-coupled outputs |
| $\Delta$ Vocm_ac-coupled | $50 \Omega \times 1$ то/2 | Output common-mode shift, ac-coupled outputs |
| Vocm | $\mathrm{V}_{\text {то }}-\Delta \mathrm{V}_{\text {оСм }}=\left(\mathrm{V}_{\text {H-DC }}+\mathrm{V}_{\text {L-dC }}\right) / 2$ | Output common-mode voltage |
| $\mathrm{V}_{\text {H-DC }}$ | $\mathrm{V}_{\text {то }}-\Delta \mathrm{V}_{\text {OCM }}+\mathrm{V}_{\text {dpp-dC }} / 2$ | DC single-ended output high voltage |
| $\mathrm{V}_{\text {L-dC }}$ | $\mathrm{V}_{\text {то }}-\Delta \mathrm{V}_{\text {OCM }}-\mathrm{V}_{\text {DPP-DC/ }} / 2$ | DC single-ended output low voltage |
| $\mathrm{V}_{\text {H-PE }}$ | $\mathrm{V}_{\text {TO }}-\Delta \mathrm{V}_{\text {OCM }}+\mathrm{V}_{\text {DPPP-PE/ }}$ | Maximum single-ended output voltage |
| VL-PE | $\mathrm{V}_{\text {TO }}-\Delta \mathrm{V}_{\text {OCM }}-\mathrm{V}_{\text {DPPP.PE }} / 2$ | Minimum single-ended output voltage |



Figure 46. $V_{H}, V_{L}$, and $V_{\text {осм }}$

## SUPPLY SEQUENCING

Ideally, all power supplies should be brought up to the appropriate levels simultaneously (power supply requirements are set by the supply limits in Table 1 and the absolute maximum ratings listed in Table 3). In the event that the power supplies to the AD8155 are brought up separately, the supply power-up sequence is as follows: $\mathrm{DV}_{\mathrm{CC}}$ is powered first, followed by $\mathrm{V}_{\mathrm{CC}}$, and lastly $\mathrm{V}_{\text {TTI }}$ and $\mathrm{V}_{\text {TTo. }}$. The power-down sequence is reversed, with $\mathrm{V}_{\text {TTI }}$ and $V_{\text {тто }}$ being powered off first.
$\mathrm{V}_{\text {тті }}$ and $\mathrm{V}_{\text {тто }}$ contain $E S D$ protection diodes to the $\mathrm{V}_{\text {сс }}$ power domain (see Figure 38 and Figure 39). To avoid a sustained high current condition in these devices ( $\mathrm{I}_{\text {Sustained }}<64 \mathrm{~mA}$ ), the $\mathrm{V}_{\text {TTI }}$ and $V_{\text {тто }}$ supplies should be powered on after $V_{C C}$ and should be powered off before $\mathrm{V}_{\mathrm{Cc}}$.

If the system power supplies have a high impedance in the powered off state, then supply sequencing is not required provided the following limits are observed:

- Peak current from $V_{\text {Tті }}$ or $V_{\text {Tто }}$ to $V_{C C}<200 \mathrm{~mA}$
- Sustained current from $\mathrm{V}_{\text {Tti }}$ or $\mathrm{V}_{\text {Tто }}$ to $\mathrm{V}_{\mathrm{CC}}<64 \mathrm{~mA}$


## SINGLE SUPPLY vs. MULTIPLE SUPPLY OPERATION

The AD8155 supports a flexible supply voltage of 1.8 V to 3.3 V . For some dc-coupled links, 1.2 V or ground-referenced signaling may be desired. In these cases, the AD8155 can be run with a split supply configuration. An example is shown in Figure 47.


Figure 47. Multiple Supply Operation

Table 21. Alternate Supply Configuration Examples

| Signal Level | $\mathbf{V}_{\mathrm{CC}}, \mathbf{V}_{\mathrm{TTI}}, \mathbf{V}_{\mathrm{TTO}}$ | $\mathbf{V}_{\mathrm{EE}}$ |
| :--- | :--- | :--- |
| 1.2 V CML | 1.2 V | $-2.1 \mathrm{~V} \leq \mathrm{V}_{\mathrm{EE}} \leq-0.6 \mathrm{~V}$ |
| $\mathrm{GND}-400 \mathrm{mV}$ diff | GND | $-3.3 \mathrm{~V} \leq \mathrm{V}_{\mathrm{EE}} \leq-1.8 \mathrm{~V}$ |

The AD8155 control signals are always referenced between
$D V_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{EE}}$ and, when using a split supply configuration, logic level-shift circuits should be used. The evaluation board design shows the use of the Analog Devices, Inc., ADUM1250 $\mathrm{I}^{2} \mathrm{C}$ isolator and a level shifter to level-shift the SCL and SDA signals (for information about the evaluation board, see the Ordering Guide).

## Evaluation of DC-Coupled Links

When evaluating the AD8155 dc-coupled, note that most lab equipment is ground referenced whereas the AD8155 high speed I/O are connected by $50 \Omega$ on-die termination resistors to $\mathrm{V}_{\text {тті }}$ and $\mathrm{V}_{\text {тто }}$. To interface the AD8155 to ground-referenced, high speed instrumentation (for example, the $50 \Omega$ inputs of a high speed oscilloscope), it is necessary to level-shift the outputs by either using a dc-blocking network or powering the AD8155 between ground and a negative supply.

For example, to evaluate 1.8 V dc-coupled transmitter performance with a $50 \Omega$ ground-referenced oscilloscope, use the following supply configuration:

$$
\begin{aligned}
& V_{C C}=V_{T T O}=V_{T T I}=\text { Ground } \\
& V_{E E}=-1.8 \mathrm{~V}
\end{aligned}
$$

Ground $<$ DVCC $<1.5 \mathrm{~V}$

## INITIALIZATION SEQUENCE FOR LOW POWER AND LOS_INT OPERATION

The following programming sequence is required to initialize the device in a low power mode and to enable the LOS_INT: set the reserved bits to Logic 1 in the RX and TX control registers by writing the value 0 x 0 C to the $0 \mathrm{x} 40,0 \times 48,0 \mathrm{x} 80$, $0 \mathrm{x} 88,0 \mathrm{xC} 0$, and 0 xC 8 registers.

## PRINTED CIRCUIT BOARD (PCB) LAYOUT GUIDELINES

The high speed differential inputs and outputs should be routed with $100 \Omega$ controlled impedance differential transmission lines. The transmission lines, either microstrip or stripline, should be referenced to a solid low impedance reference plane. An example of a PCB cross-section is shown in Figure 48. The trace width (W), differential spacing ( S ), height above reference plane (H), and dielectric constant of the PCB material determine the characteristic impedance. Adjacent channels should be kept apart by a distance greater than 3 W to minimize crosstalk.


Figure 48. Example of a PCB Cross-Section

## Thermal Paddle Design

The LFCSP is designed with an exposed thermal paddle to conduct heat away from the package and into the PCB. By incorporating thermal vias into the PCB thermal paddle, heat is dissipated more effectively into the inner metal layers of the PCB. To ensure device performance at elevated temperatures, it is important to have a sufficient number of thermal vias incorporated into the design. An insufficient number of thermal vias results in a $\theta_{\mathrm{JA}}$ value larger than specified in Table 1. Additional PCB footprint and assembly guidelines are described in the AN-772 Application Note, A Design and Manufacturing Guide for the Lead Frame Chip Scale Package (LFCSP).

It is recommended that a via array of $4 \times 4$ or $5 \times 5$ with a diameter of 0.3 mm to 0.33 mm be used to set a pitch between 1.0 mm and 1.2 mm . A representative of these arrays is shown in Figure 49.


Figure 49. PCB Thermal Paddle and Via

## Stencil Design for the Thermal Paddle

To effectively remove heat from the package and to enhance electrical performance, the thermal paddle must be soldered (bonded) to the PCB thermal paddle, preferably with minimum voids. However, eliminating voids may not be possible because of the presence of thermal vias and the large size of the thermal paddle for larger size packages. Also, outgassing during the reflow process may cause defects (splatter, solder balling) if the solder paste coverage is too big. It is recommended that smaller multiple openings in the stencil be used instead of one big opening for printing solder paste on the thermal paddle region. This typically results in $50 \%$ to $80 \%$ solder paste coverage. Figure 50 shows how to achieve these levels of coverage.

Voids within solder joints under the exposed paddle can have an adverse affect on high speed and RF applications, as well as on thermal performance. Because the LFCSP package incorporates a large center paddle, controlling solder voiding within this region can be difficult. Voids within this ground plane can increase the current path of the circuit. The maximum size for a void should be less than via pitch within the plane. This assures that any one via is not rendered ineffectual when any void increases the current path beyond the distance to the next available via.

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Figure 50.Typical Thermal Paddle Stencil Design
Large voids in the thermal paddle area should be avoided. To control voids in the thermal paddle area, solder masking may be required for thermal vias to prevent solder wicking inside the via during reflow, thus displacing the solder away from the interface between the package thermal paddle and thermal paddle land on the PCB. There are several methods employed for this purpose, such as via tenting (top or bottom side), using dry film solder mask; via plugging with liquid photo-imagible (LPI) solder mask from the bottom side; or via encroaching. These options are depicted in Figure 51. In case of via tenting, the solder mask diameter should be 100 microns larger than the via diameter.


Figure 51. Solder Mask Options for Thermal Vias: (a) Via Tenting from the Top; (b) Via Tenting from the Bottom; (c)Via Plugging, Bottom; and (d) Via Encroaching, Bottom

A stencil thickness of 0.125 mm is recommended for 0.4 mm and 0.5 mm pitch parts. The stencil thickness can be increased to 0.15 mm to 0.2 mm for coarser pitch parts. A laser-cut, stainless steel stencil is recommended with electropolished trapezoidal walls to improve the paste release. Because not enough space is available underneath the part after reflow, it is recommended that no clean Type 3 paste be used for mounting the LFCSP. Inert atmosphere is also recommended during reflow.

## REGISTER MAP

All registers are port-level and global registers, unless otherwise noted.
Table 22. Register Definitions

| Mnemonic | Addr. | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Default |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Reset | 0x00 |  |  |  |  |  |  |  | RESET |  |
| Switch Control 1 | 0x01 |  | LBC | LBB | LBA | Set to 0 | Set to 0 | SELAb/B[1] | SELAb/B[0] | 0x00 |
| Switch Control 2 | 0x02 |  |  |  | SEL4G |  |  |  | BICAST | 0x00 |
| Global Squelch Ctrl | 0x04 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | GSQLCH_ENB | Reserved; set to 1 | Reserved; set to 1 | Reserved; set to 1 | 0x0F |
| Switch Core/ Headroom | $0 \times 05$ |  | $\begin{aligned} & \text { TX_HEAD } \\ & \text { ROOM_C } \end{aligned}$ | $\begin{aligned} & \text { TX_HEAD } \\ & \text { ROOM_B } \end{aligned}$ | $\begin{aligned} & \text { TX_HEAD } \\ & \text { ROOM_A } \end{aligned}$ |  |  |  | XCORE_ENB | $0 \times 01$ |
| Mode | 0x0F | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | MODE[1] | MODE[0] | 0x00 |
| RXA Disable | 0x40 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved | Reserved | RXDIS A1 | RXDIS A0 | 0x00 |
| RXA EQ <br> Setting | $0 \times 41$ | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | AEQ[3] | AEQ[2] | AEQ[1] | AEQ[0] | 0x00 |
| RXA LOS Control | $0 \times 51$ | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | LOS_FILT | Reserved; set to 0 | LOS_ENB | 0x05 |
| RXA Lane 1/ RXA Lane 0 EQ Setting | $0 \times 42^{1}$ | A1EQ[3] | A1EQ[2] | A1EQ[1] | A1EQ[0] | A0EQ[3] | A0EQ[2] | A0EQ[1] | A0EQ[0] | $0 \times 00$ |
| RXA P/N Swap | $0 \times 44^{1}$ | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | PNA1 | PNAO | 0x00 |
| RXA LOS Status | $0 \times 451$ | Reserved | Reserved | LOSA1 sticky | LOSAO sticky | Reserved | Reserved | LOSA1 active | LOSAO active |  |
| TXA Disable | 0x48 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved | Reserved | TXDIS A1 | TXDIS A0 | $0 \times 00$ |
| TXA Level/PE Control | 0x49 |  |  | ALEV[1] | ALEV[0] |  | APE[2] | APE[1] | APE[0] | $0 \times 20$ |
| TXA Lane1/ TXA Lane 0 PE Setting | $0 \times 4 A^{1}$ |  | A1PE[2] | A1PE[1] | A1PE[0] |  | AOPE[2] | AOPE[1] | AOPE[0] | 0x00 |
| TXA Per-Lane Level Setting | $0 \times 4 C^{1}$ | Reserved | Reserved | Reserved | Reserved | A1OLEV[1] | A1OLEV[0] | A0OLEV[1] | A0OLEV[0] | 0xAA |
| RXB Disable | 0x80 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved | Reserved | RXDIS B1 | RXDIS B0 | 0x00 |
| RXBEQ <br> Setting | 0x81 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | BEQ[3] | BEQ[2] | BEQ[1] | BEQ[0] | 0x00 |
| RXB LOS Ctrl | 0x91 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | LOS_FILT | Reserved; set to 0 | LOS_ENB | $0 \times 05$ |
| RXB Lane 1/ RXB Lane 0 EQ Setting | 0x82 ${ }^{1}$ | B1EQ[3] | B1EQ[2] | B1EQ[1] | B1EQ[0] | B0EQ[3] | B0EQ[2] | B0EQ[1] | B0EQ[0] | 0x00 |
| RXB P/N Swap | 0x84 ${ }^{1}$ | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | PNB1 | PNB0 | $0 \times 00$ |
| RXB LOS <br> Status | 0x85 ${ }^{1}$ | Reserved | Reserved | LOSB1 sticky | LOSB0 sticky | Reserved | Reserved | LOSB1 active | LOSBO active |  |
| TXB Disable | 0x88 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved | Reserved | TXDIS B1 | TXDIS B0 | 0x00 |
| TXB Level/PE Control | 0x89 |  |  | BLEV[1] | BLEV[0] |  | BPE[2] | BPE[1] | BPE[0] | 0x20 |
| TXB Lane1/ TXB Lane 0 PE Setting | $0 \times 8 A^{1}$ |  | B1PE[2] | B1PE[1] | B1PE[0] |  | BOPE[2] | BOPE[1] | BOPE[0] | 0x00 |
| TXB Per-Lane Level Setting | $0 \times 8 C^{1}$ | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | B1OLEV[1] | B1OLEV[0] | B0OLEV[1] | B0OLEV[0] | 0xAA |
| RXC Disable | 0xC0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved | Reserved | RXDIS C1 | RXDIS C0 | 0x00 |

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| Mnemonic | Addr. | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Default |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RXC EQ <br> Setting | 0xC1 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | CEQ[3] | CEQ[2] | CEQ[1] | CEQ[0] | 0x00 |
| RXC LOS Ctrl | 0xD1 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | LOS_FILT | Reserved; set to 0 | LOS_ENB | 0x05 |
| RXC Lane 1/ <br> RXC Lane 0 Setting | $0 \times C 2{ }^{1}$ | C1EQ[3] | C1EQ[2] | C1EQ[1] | C1EQ[0] | COEQ[3] | COEQ[2] | COEQ[1] | C0EQ[0] | 0x00 |
| RXC P/N Swap | $0 \times C 4{ }^{1}$ | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | PNC1 | PNC0 | 0x00 |
| RXC LOS <br> Status | $0 \times C 5{ }^{1}$ | Reserved | Reserved | LOSC1 sticky | LOSC0 sticky | Reserved | Reserved | LOSC1 <br> active | LOSCO active |  |
| TXC Disable | 0xC8 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved; set to 0 | Reserved | Reserved | TXDIS C1 | TXDIS C0 | 0x00 |
| TXC Level/PE Control | 0xC9 |  |  | CLEV[1] | CLEV[0] |  | CPE[2] | CPE[1] | CPE[0] | 0x20 |
| TXC Lane1/ TXC Lane 0 PE Setting | $0 \times C{ }^{1}$ |  | C1PE[2] | C1PE[1] | C1PE[0] |  | COPE[2] | COPE[1] | COPE[0] | 0x00 |
| TXC Per-Lane Level Setting | $0 \times C C^{1}$ | Reserved | Reserved | Reserved | Reserved | C1OLEV[1] | C1OLEV[0] | C0OLEV[1] | C0OLEV[0] | 0xAA |

[^2]
## OUTLINE DIMENSIONS



ORDERING GUIDE

| Model | Temperature Range | Package Description | Package Option |
| :--- | :--- | :--- | :--- |
| AD8155ACPZ $^{1}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 64-Lead Lead Frame Chip Scale Package [LFCSP_VQ] | CP-64-2 |
| AD8155ACPZ-R7 ${ }^{1}$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 64-Lead Lead Frame Chip Scale Package [LFCSP_VQ] | CP-64-2 |
| AD8155-EVALZ ${ }^{1}$ |  | Evaluation Board |  |

[^3]
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## NOTES


[^0]:    ${ }^{1}$ Bicast is off, loopback is off on all ports, preemphasis is set to minimum on all ports, and equalization is set to minimum on all ports.
    ${ }^{2} \mathrm{~V}_{\text {ICM }}$ is the input common-mode voltage.
    ${ }^{3}$ Low power mode is obtained by following the steps identified in the Initialization Sequence for Low Power and LOS_INT Operation section.
    ${ }^{4}$ EQ control pins (EQ_A, EQ_B, EQ_C) require $5 \mathrm{k} \Omega$ in series when $D V_{c c}>V_{c c}$.

[^1]:    ${ }^{1}$ Symbol definitions are shown in Table 20.
    ${ }^{2}$ TX[A/B/C] level/PE control registers are port level control registers at Address $0 \times 49$, Address $0 \times 89$, and Address $0 \times C 9$. Per-lane level and PE control are in separate registers.
    ${ }^{3}$ This setting requires TX_HEADROOM $=1$ to ensure adequate output compliance.
    ${ }^{4}$ This setting is not recommended for ac-coupled outputs because the theoretical output low level is below the minimum output voltage limit listed in Table 1 .
    ${ }^{5}$ This setting is not recommended because the output level is below the minimum output voltage limit listed in Table 1 . Use $\mathrm{V}_{\mathrm{CC}}=2.5 \mathrm{~V}$ and TX _HEADROOM $=1$.

[^2]:    ${ }^{1}$ Per-lane registers.

[^3]:    ${ }^{1} Z=$ RoHS Compliant Part.

